## PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date	
Jack Lee	01/07/2009	
Po-Hui Chen	01/07/2009	

#### **RECEIVING PARTY DATA**

Name:	Po-Huei Chen	
Street Address:	No. 185, Bih Shing Rd., Jia Shiang Village, Fen Yuan	
City:	Chang Hua Hsien	
State/Country:	TAIWAN	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12058747

### **CORRESPONDENCE DATA**

Fax Number: (361)579-9966

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 3614859179

Email: bs@pat-bangshia.com

Correspondent Name: **BANGER SHIA** 

Address Line 1: 102 LINDENCREST CT. Address Line 4: SUGAR LAND, TEXAS 77479

ATTORNEY DOCKET NUMBER: CFP-4037 (C-399) NAME OF SUBMITTER: **BANGER SHIA** 

**Total Attachments: 3** 

500754534

source=CFP-4037 assignment deed#page1.tif source=CFP-4037 assignment deed#page2.tif source=CFP-4037 assignment deed#page3.tif

**PATENT** 

**REEL: 022108 FRAME: 0597** 

# ASSIGNMENT DEED

entire right, title and interest -

PATENT REEL: 022108 FRAME: 0598 assignment and conveyance unto said Assignee, its successors and/or assigns, Assignor's entire right, title and interest —

(1) In and to an invention entitled <u>SUPPLY METHOD WITHOUT COOLING</u>

MEDIUM FOR AN	AIR CONDITION	ONER AN	D A SY	STEM TH	EREOF		· · -	
as described in United S	States Patent A	Application	on Seri	al No	12/05	8,747	, file	ed on
03/30/2008	; which	issued	into	United	States	Letters	Patent	No.
· · ·	on			, i	ncluding	the right	to recove	r for
past infringements there	of.							
` '	said Applicat							
all other applications for	or letters pater	nt of the	Unite	d States	of Amer	ica (inclu	ding ren	ewal,
divisional, continuation	, continuation	-in-part,	substit	ute and r	eissue aj	pplication	s) based	upon
said invention, includir	ng extensions	and reis	sues, i	f any, to	the full	ends of	the term	s for
which said Letters Pater	nt of the Unite	d states h	as bee	n granted	l.			

(3) In and to all applications for said invention, now or hereafter filed in countries foreign to the United States of America, and in and to any and all letters patent granted on said applications to the full ends of the terms for which said Letters Patent may be granted.

Assignor further covenants and agrees that it has not executed and will not execute any documents in conflict herewith, and it further agrees that it will at any time upon request by Assignees execute and deliver any and all papers that may be necessary or desirable to perfect title to said invention, Application for Letters Patent, and the Letters Patent to Assignees, and if Assignees desires to file one or more divisional, continuation, continuation-in-part, or substitute applications of or for said Letters Patent of the United States of America, or to secure a reissue or extension of such Letters Patent, or to file a disclaimer relating thereto, Assignors will upon request by Assignees sign all papers, make all rightful oaths and do all lawful acts requisite of it for such reissue or extension, or the procuring thereof, and for the filing of such disclaimer, but at the expense of Assignees, its successors and/or assigns.

Assignor further agrees that it will at any time upon request by Assignee communicate

PATENT REEL: 022108 FRAME: 0599 to Assignee any facts relating to said invention and Letters Patent or the history thereof, know to Assignor and cause its agent(s) to testify to the same in any interference or any litigation when requested so to do by Assignee.

And the Commissioner of Patents and Trademarks of the United States of America and comparable officials in countries foreign to the United States of America to record and/or issue said Letters Patent, and the like to Assignee as assignee of Assignor's entire right, title and interest therein.

Signed at TAICHUNG, TAIWAN	this 7TH day of JAN. 2009
Assignor:	CHEN, PO-HUE1
Name: Lee, Jack / Chen, Po-Hui Title: APPLICANTS Date: 01/07/2009	
Witness:	
Signature:	_
Name:	
Address:	
Date:	

PATENT REEL: 022108 FRAME: 0600

**RECORDED: 01/14/2009**